

APPLICATION DATA SHEET

Electronic Version 0.0.11

Stylesheet Version: 1.0

Attorney Docket Number: NAUP0481USA

Publication Filing Type: new-utility

Application Type: utility

Title of Invention: SOLDER PADS FOR IMPROVING RELIABILITY OF A PACKAGE

Customer Number Attorney: 027765



Customer Number Correspondence Address: 027765



INVENTOR(s):

Primary Citizenship: R.O.C.

Given Name: Kuo-Ming

Family Name: Chen

Residence City: Hsin-Chu Hsien

Residence Country: TW

Address: No. 16-1, Ta-Lin Tsun, Pei-Pu Hsiang, Hsin-Chu Hsien,
Taiwan, R.O.C.

Hsin-Chu Hsien , TW